PNP Silicon AF Transistor
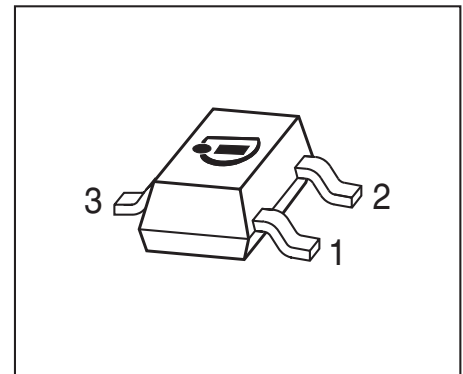
• Low collector-emitter saturation voltage

• Complementary type: SMBTA06 / MMBTA06(NPN)

• Pb-free (RoHS compliant) package

• Qualified according AEC Q101

Type	Marking	Pin Configuration			Package
SMBTA56/MMBTA56	s2G	1=B	2=E	3=C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	80	V
Collector-base voltage	V_{CBO}	80	
Emitter-base voltage	V_{EBO}	4	
Collector current	I_C	500	mA
Peak collector current, $t_p \leq 10$ ms	I_{CM}	1	A
Base current	I_B	100	mA
Peak base current	I_{BM}	200	
Total power dissipation- $T_S \leq 79°C$	P_{tot}	330	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point[1]	R_{thJS}	≤ 215	K/W

[1]For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

2011-08-05

Electrical Characteristics at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage I_C = 1 mA, I_B = 0	$V_{(BR)CEO}$	80	-	-	V
Collector-base breakdown voltage I_C = 100 µA, I_E = 0	$V_{(BR)CBO}$	80	-	-	
Emitter-base breakdown voltage I_E = 10 µA, I_C = 0	$V_{(BR)EBO}$	4	-	-	
Collector-base cutoff current V_{CB} = 80 V, I_E = 0 V_{CB} = 80 V, I_E = 0 , T_A = 150 °C	I_{CBO}	- -	- -	0.1 20	µA
Collector-emitter cutoff current V_{CE} = 60 V, I_B = 0	I_{CEO}	-	-	0.1	
DC current gain[1] I_C = 10 mA, V_{CE} = 1 V I_C = 100 mA, V_{CE} = 1 V	h_{FE}	100 100	- -	- -	-
Collector-emitter saturation voltage[1] I_C = 100 mA, I_B = 10 mA	V_{CEsat}	-	-	0.25	V
Base-emitter voltage[1] I_C = 100 mA, V_{CE} = 1 V	$V_{BE(ON)}$	-	-	1.2	
AC Characteristics					
Transition frequency I_C = 20 mA, V_{CE} = 5 V, f = 20 MHz	f_T	-	100	-	MHz
Collector-base capacitance V_{CB} = 10 V, f = 1 MHz	C_{cb}	-	7	-	pF

[1]Pulse test: t < 300µs; D < 2%

2011-08-05

DC current gain $h_{FE} = f(I_C)$
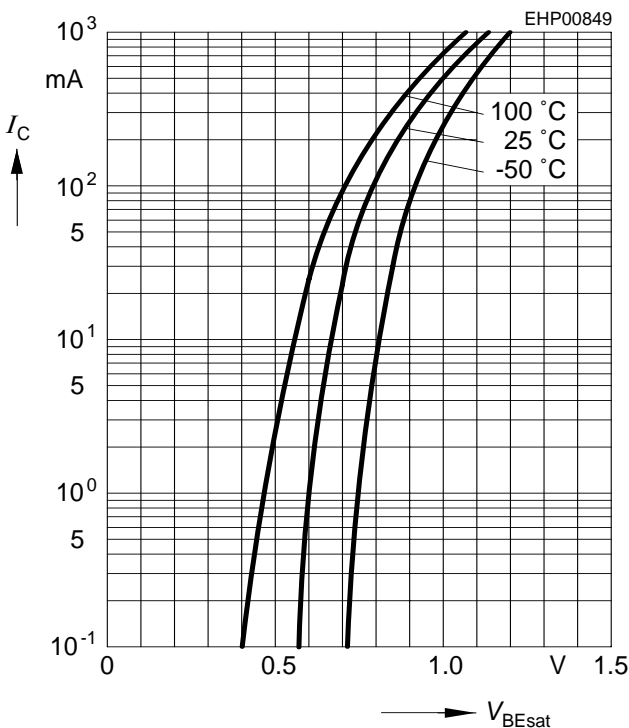
$V_{CE} = 1$ V

EHP00852
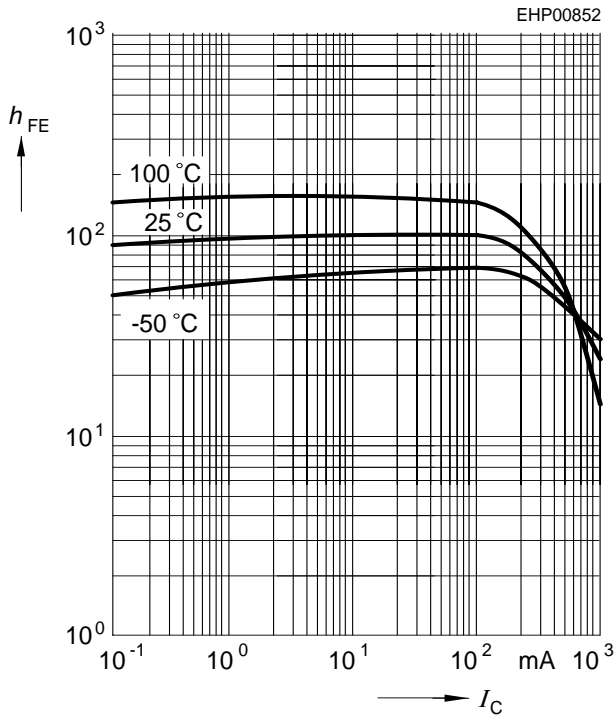
Collector-emitter saturation voltage

$I_C = f(V_{CEsat})$, $h_{FE} = 10$

EHP00850
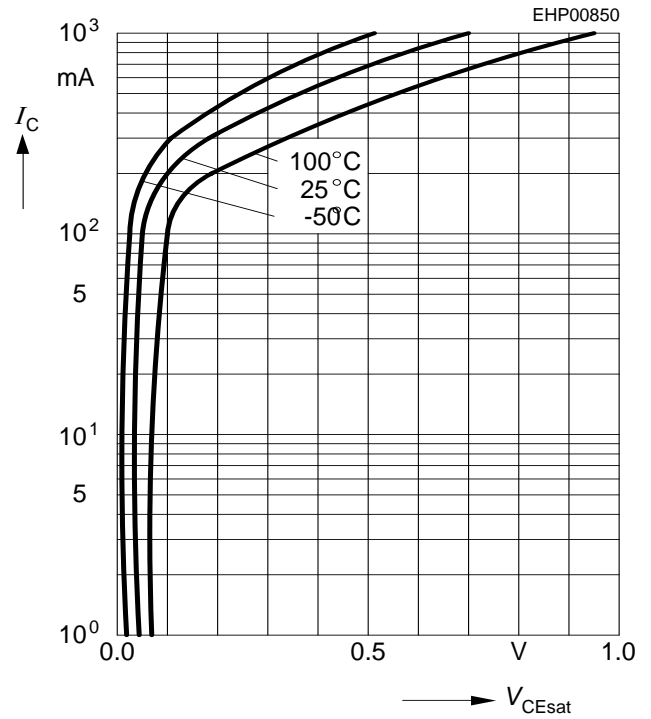
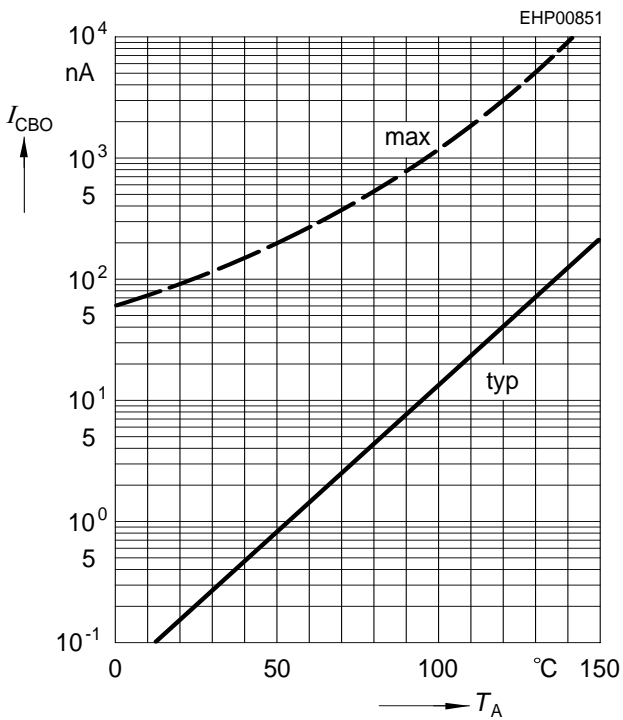**Base-emitter saturation voltage**

$I_C = f(V_{BEsat})$, $h_{FE} = 10$

EHP00849

Collector current $I_C = f(V_{BE})$
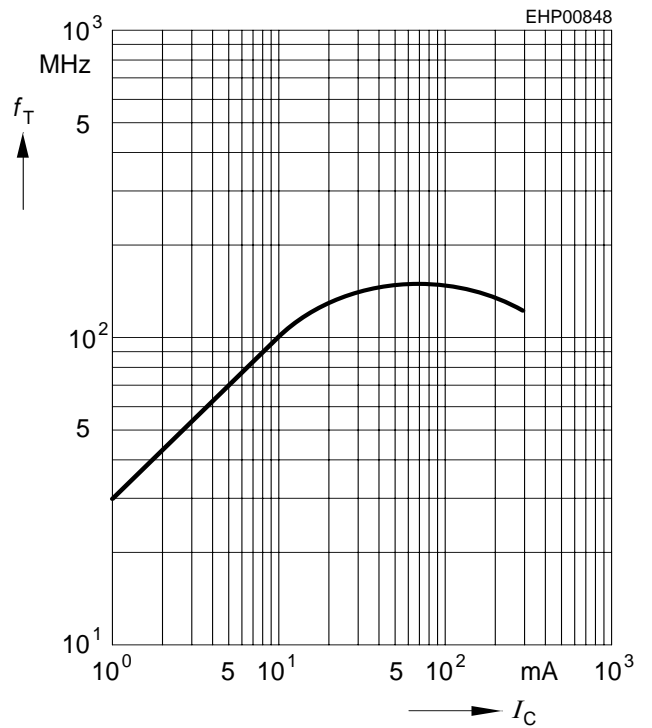
$V_{CE} = 1$V

EHP00846

3

2011-08-05
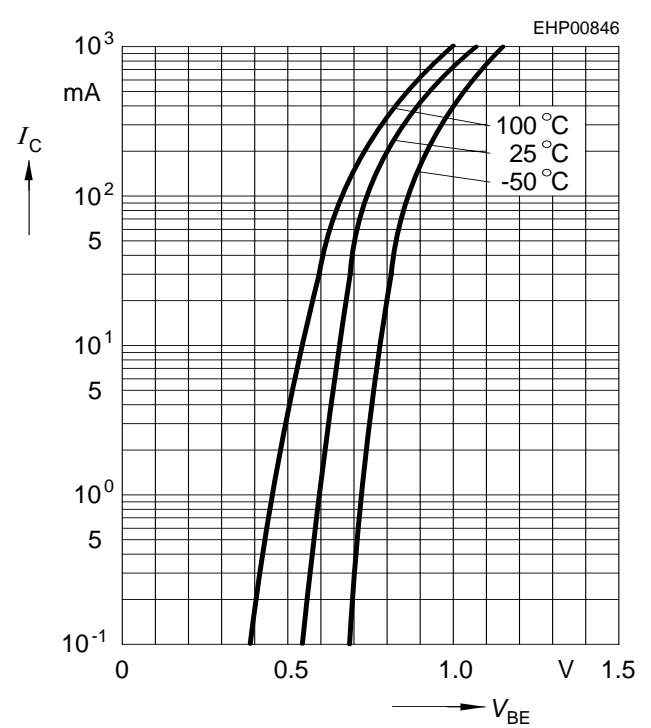
Collector cutoff current $I_{CBO} = f(T_A)$

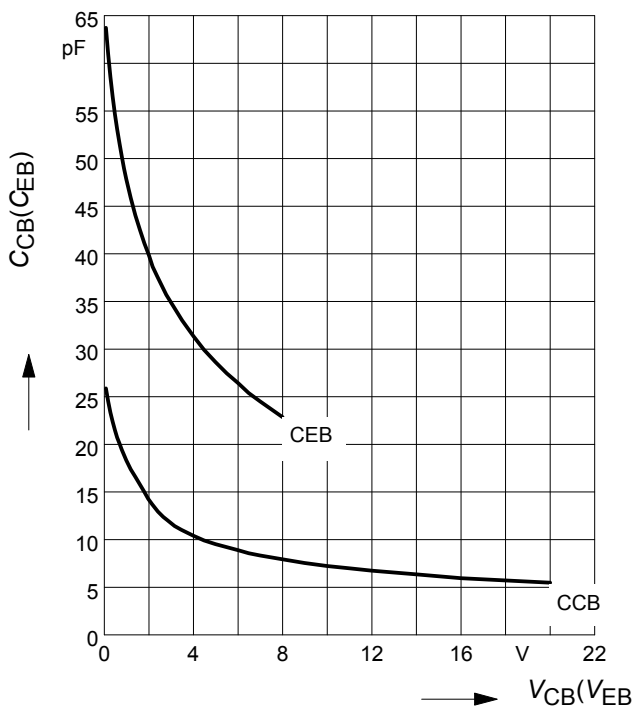V_{CB} = 80 V

EHP00851

Transition frequency $f_T = f(I_C)$

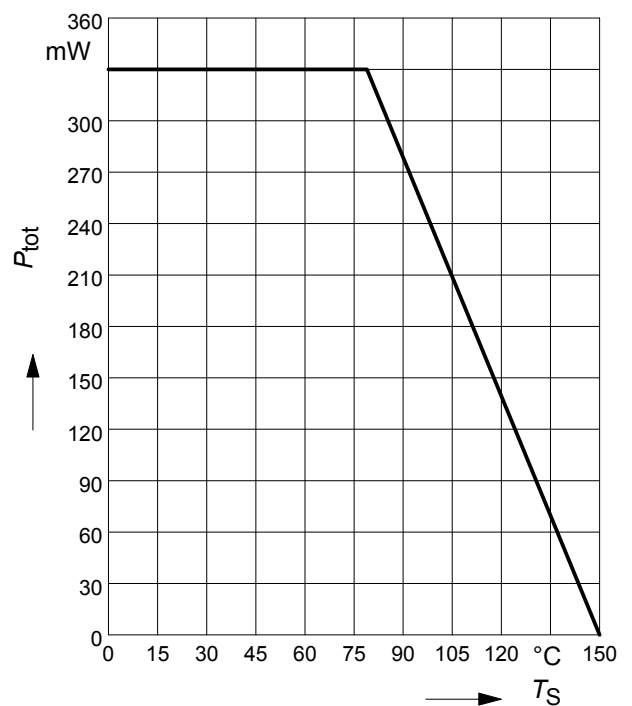V_{CE} = parameter in V, f = 2 GHz

EHP00848

Collector-base capacitance $C_{cb} = f(V_{CB})$

Emitter-base capacitance $C_{eb} = f(V_{EB})$
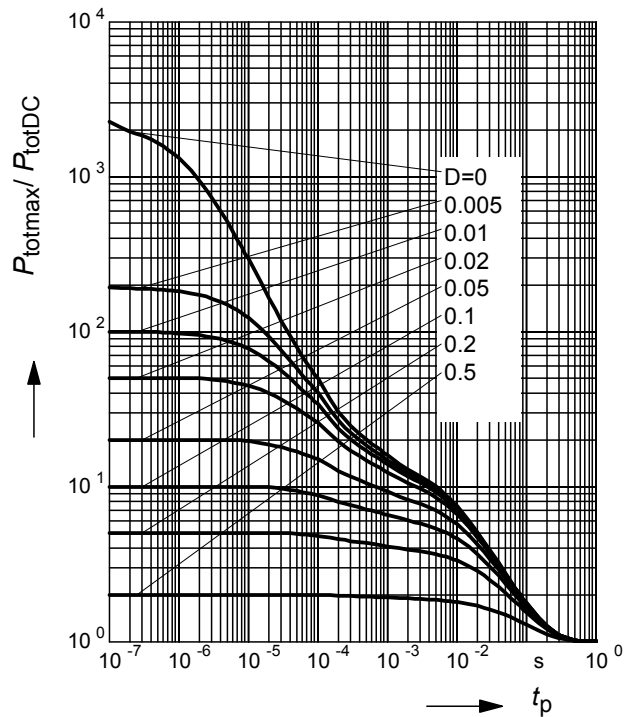

Total power dissipation $P_{tot} = f(T_S)$

4

2011-08-05

Permissible Pulse Load $R_{thJS} = f(t_p)$
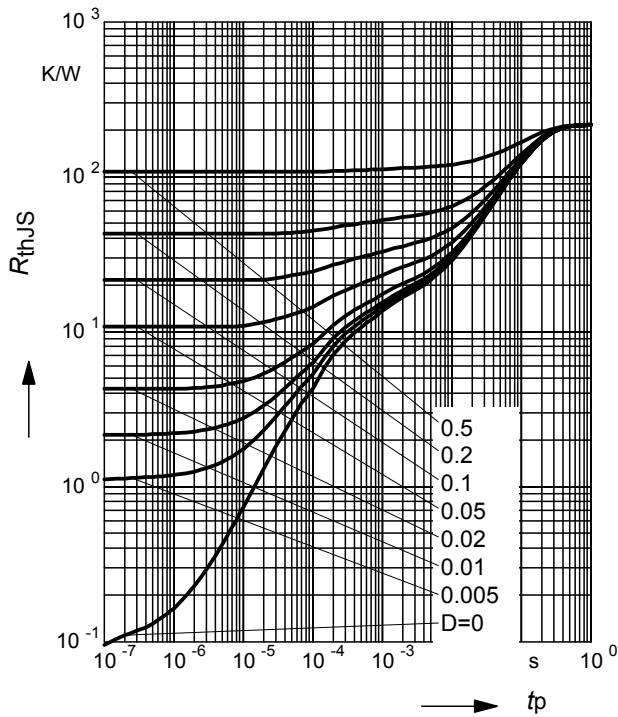
Permissible Pulse Load

$P_{totmax}/P_{totDC} = f(t_p)$

2011-08-05

Package Outline

2.9 ±0.1   B

3

2.4 ±0.15   1 ±0.1

0.15 MIN.

0.1 MAX.

10° MAX.   10° MAX.

1.3 ±0.1

A

0.08...0.15

0...8°

0.4 +0.1/-0.05 1)

C

0.95

1.9

⊕ 0.25 Ⓜ B C

= 0.2 Ⓜ A

1) Lead width can be 0.6 max. in dambar area

Foot Print

0.8

0.9

1.3

0.8   1.2   0.9

Marking Layout (Example)

Ⓘnfineon
Manufacturer

EH S

56

2005, June
Date code (YM)

Pin 1

BCW66
Type code

Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel

4

0.9

0.2

2.13

2.65

8

Pin 1

3.15

1.15

Edition 2009-11-16

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